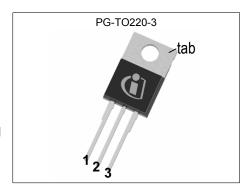


MOSFET

600V CoolMOS™ CM8 Power Transistor

The CoolMOS™ 8th generation platform is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The 600V CoolMOS™ CM8 series is the successor to the CoolMOS™ 7. It combines the benefits of a fast switching SJ MOSFET with excellent ease of use, e.g low ringing tendency, implemented fast body diode (CFD) for all products with outstanding robustness against hard commutation and excellent ESD capability. Furthermore, extremely low switching and conduction losses of CM8, make switching applications even more efficient.



Features

- Suitable for hard and soft switching topologies thanks to an outstanding commutation ruggedness
- Significant reduction of switching and conduction losses
- Best in class R_{DS(on)} per package products enabled by ultra low R_{DS(on)}*A

Benefits

- Ease of use and fast design-in through low ringing tendency and usage across PFC and PWM stages
- Simplified thermal management thanks to our advanced die attach technique
- Increased power density solutions enabled by using products with smaller footprint and higher manufacturing quality due state of the art ESD protection
- Suitable for a wide variety of applications and power ranges

Potential applications

- Power supplies and converters
- PFC stages & LLC resonant converters
- High efficiency switching applications
- e.g. Server, Telecom, EV Charging, UPS

Product validation

Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



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Parameter	Value	Unit				
V _{DS} @ T _{j,max}	650	V				
R _{DS(on),max}	37	mΩ				
$Q_{g,typ}$	79	nC				
I _{D,pulse}	230	А				
E _{oss} @ 400V	10.6	μJ				
Body diode di _F /dt	1300	A/µs				
ESD class (HBM)	2	-				

Type / Ordering Code	Package		Related Links
IPP60R037CM8	PG-TO220-3	60R037C8	see Appendix A

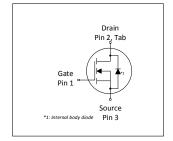










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600V CoolMOS™ CM8 Power Transistor IPP60R037CM8



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Davamatav	Cumbal		Value	s	11111111	N	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	70 44	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	230	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	135	mJ	I _D =7.8A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	0.68	mJ	I _D =7.8A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	7.8	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	390	W	T _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Extended operating junction temperature	T _j	150	-	175	°C	≤50 h in the application lifetime	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	70	Α	T _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	230	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ ≤70A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _F /dt	-	-	1300	A/μs V_{DS} =0400V, I_{SD} ≤70A, T_{j} =29 see table 8		
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	$V_{\rm rms}$, $T_{\rm C}$ =25°C, t =1min	

 $^{^{1)}}$ Limited by $T_{j,max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$

600V CoolMOS[™] CM8 Power Transistor IPP60R037CM8



2 Thermal characteristics

Table 3 Thermal characteristics

Davamatan	Complete	Values			11	Nata / Tank Oam distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.32	K/W	-
Thermal resistance, junction - ambient		-	-	62	K/W	leaded
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	-	-	K/W	-
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

600V CoolMOS[™] CM8 Power Transistor IPP60R037CM8



3 Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 Static characteristics

Parameter	Or made at		Values			Nata / Tank Oam Jilian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	600	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	$V_{(\mathrm{GS})\mathrm{th}}$	3.7	4.2	4.7	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 0.68 \rm mA$
Zero gate voltage drain current	I _{DSS}	-	- 88.9	1 -	μA	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	0.1	μA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.031 0.068	0.037	Ω	V _{GS} =10V, I _D =27.0A, T _j =25°C V _{GS} =10V, I _D =27.0A, T _j =150°C
Gate resistance	R _G	-	1	-	Ω	f=1MHz

Table 5 Dynamic characteristics

Demonstra	Or week all		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	3458	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Output capacitance	Coss	-	43	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	133	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	1371	-	pF	I _D =constant, V _{GS} =0V, V _{DS} =0400V
Turn-on delay time	t _{d(on)}	-	23	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9
Rise time	t _r	-	11	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9
Turn-off delay time	t _{d(off)}	-	101.6	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9
Fall time	t _f	-	5.8	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =13.5A, $R_{\rm G}$ =5.3 Ω ; see table 9

 Table 6
 Gate charge characteristics

Parameter	Cymbal	Values			11	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	21	-	nC	V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V
Gate to drain charge	Q_{gd}	-	28	-	nC	V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V
Gate charge total	Q_g	-	79	-	nC	V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.9	-	V	V_{DD} =400V, I_{D} =13.5A, V_{GS} =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

600V CoolMOS™ CM8 Power Transistor

IPP60R037CM8

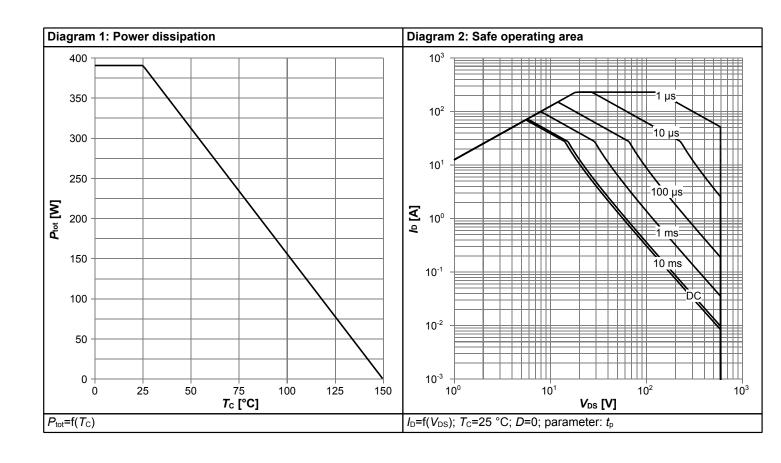


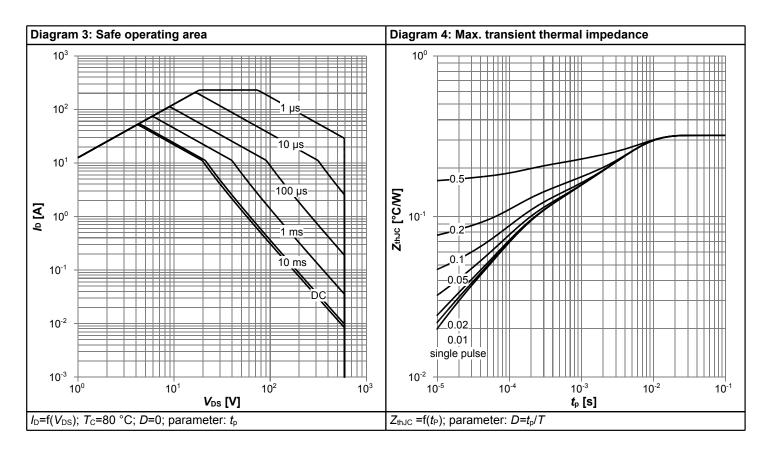
Table 7 Reverse diode characteristics

Damamatan	Cumbal	Values			Linit	Nata / Tast Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =13.5A, T _j =25°C
Reverse recovery time	t _{rr}	-	120	150	ns	V_R =400V, I_F =13.5A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	0.73	1.10	μC	V_R =400V, I_F =13.5A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	11.8	-	А	V_R =400V, I_F =13.5A, di_F/dt =100A/ μ s; see table 8

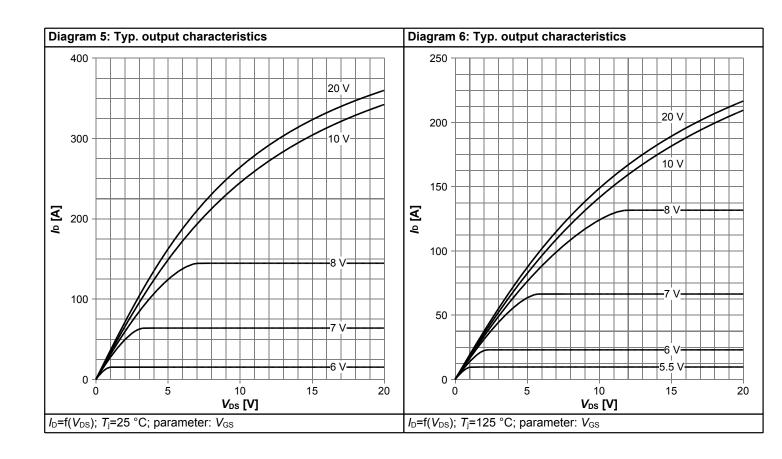


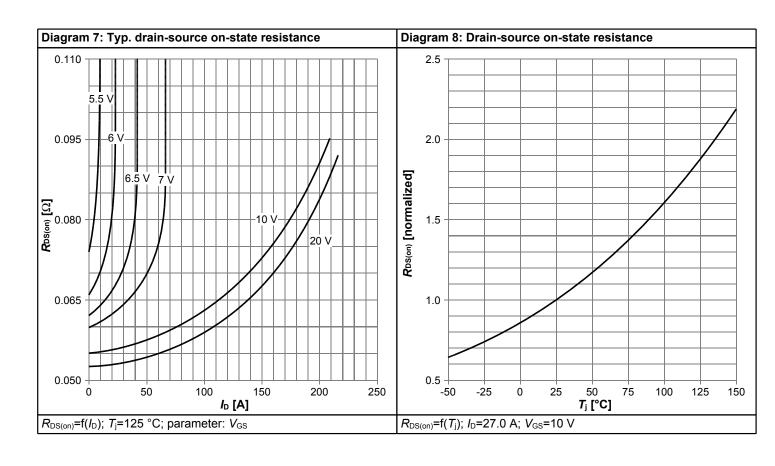
4 Electrical characteristics diagrams



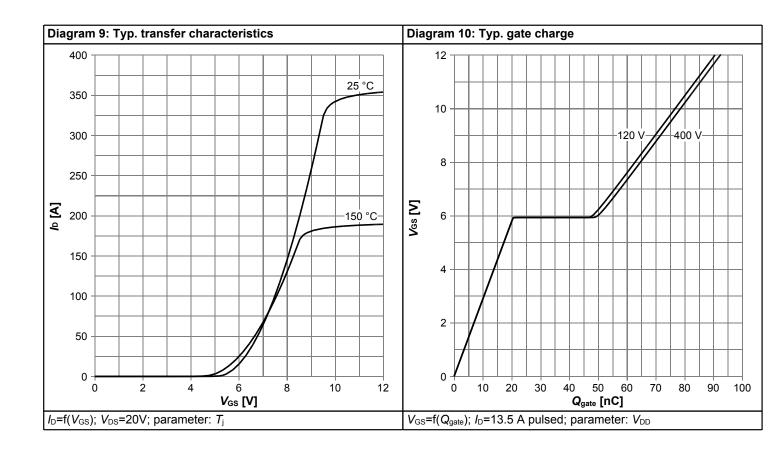


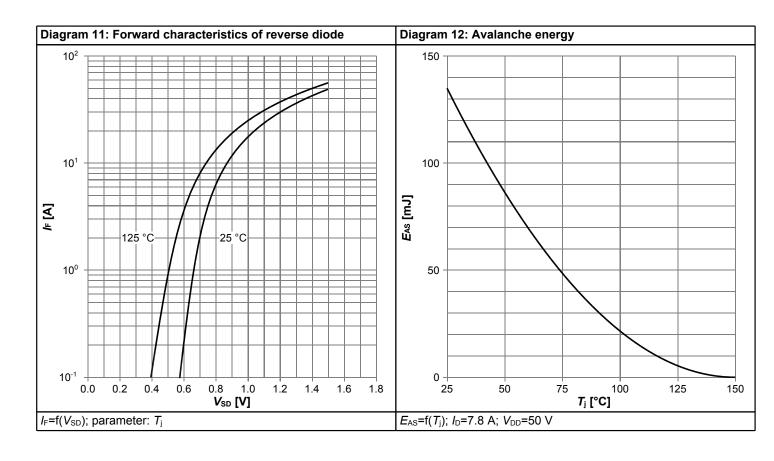




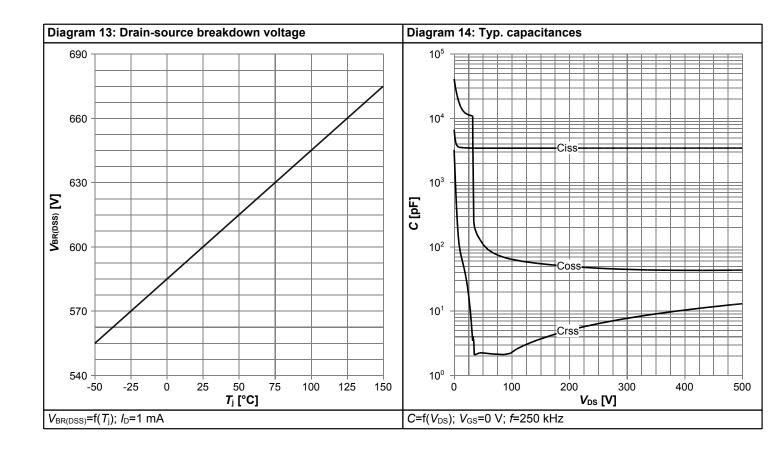


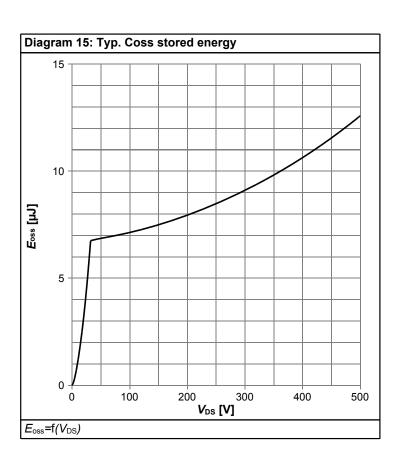














5 Test Circuits

Table 8 Diode characteristics (C8)

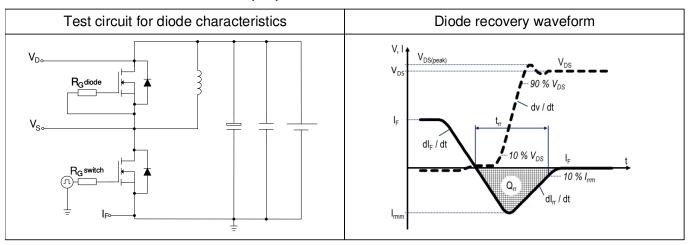


Table 9 Switching times

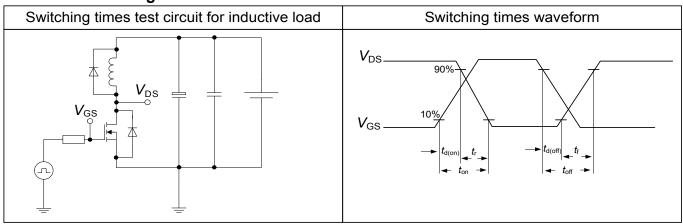
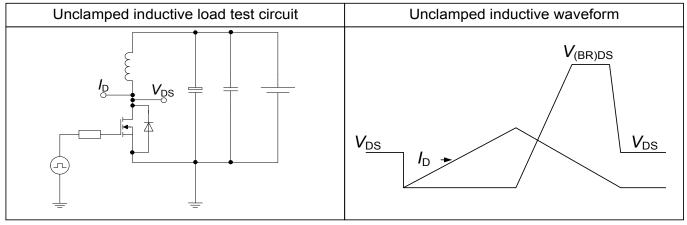


Table 10 Unclamped inductive load





6 Package Outlines

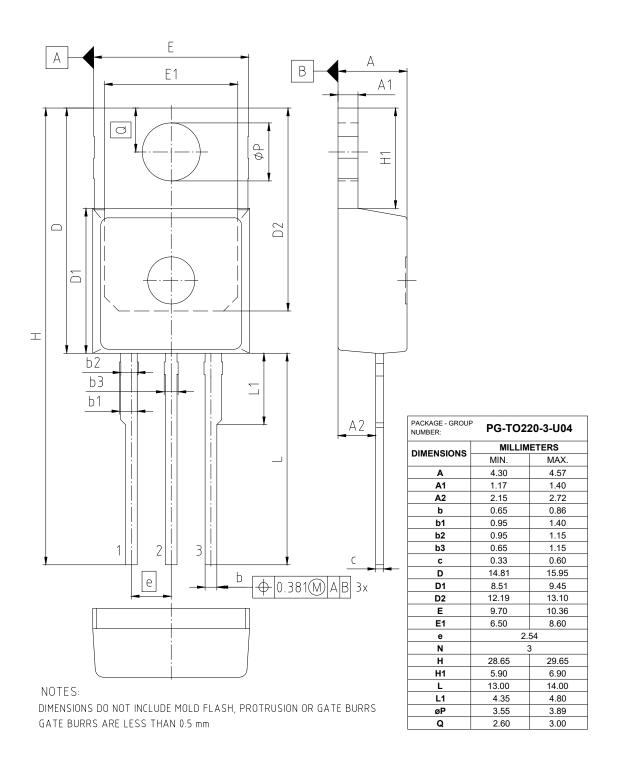


Figure 1 Outline PG-TO220-3, dimensions in mm

600V CoolMOS[™] CM8 Power Transistor IPP60R037CM8



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CM8 Webpage: www.infineon.com

• IFX CoolMOS CM8 application note: www.infineon.com

• IFX CoolMOS CM8 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

600V CoolMOS™ CM8 Power Transistor

IPP60R037CM8



Revision History

IPP60R037CM8

Revision: 2024-03-21, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-09-26	Release of final version
2.1	2023-10-14	Update of switching times
2.2	2024-03-21	Update of R _{thJC}

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Final Data Sheet 14 Rev. 2.2, 2024-03-21